Beverly Display Solutions

SPECIFICATION FOR LCD MODULE

Customer	•			
Product M	lodel: BD0	13GNB(01	
Sample co	ode:			
Designed by	ecked by		Approved by	
Final Appro	oval by Cu	stome	r	
LCM Mac	hinery OK		LCM O	K
Checked By			NG, Pi	roblem survey:
LCM Disp				
Checked By	Approve	ed By		
		ı		

^{**}The specification of "TBD" should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

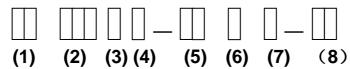
Revision History

Version	Contents	Date	Note
А	Original	2010.11.29	

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1 Numbering System



No	Definition	Specifications
(1)	TFT LCM Productor No.	BD DeverlyDisplay Solutions
(2)	Display monitor opposite angle line size	Unit :mm or mmm (size <10 inch: takes two integers; size >=10 inch: takes three integers)
(3)	Productor Types	D Digital photo frame / DVD GGPS MMP PMobil-Phone
(4)	Productor Development Series No.	By two figures characters expression from 01 to 99
(5)	Interface PIN Number	By two figures characters expression from 01 to 99
(6)	With Touch Panel Or Not	TWith T/P; NWithout T/P
(7)	LCD Type	AAUO; MCMO; CCPT; PPVI; LLG; WWintek; HHSD; TTopply; YHydis; IHitach; SSharp。。
(8)	Productor Development edition No.	By The English litters : A 1~ Z9

2 Scope

This specification applies to the TFT LCD module designed and manufactured by Beverly Display Solutions it is capable of using 262k colors mode 24bit paral lel bi-directional interface.

3 Normative Reference

GB/T4619-1996 《 Liquid Crystal Display Test Method》

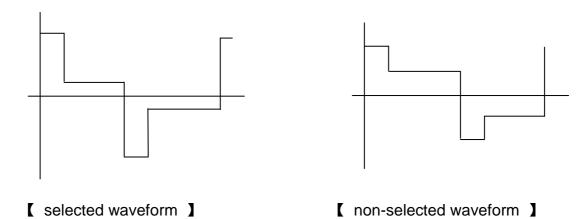
GB/T2424 《Basic environmental Testing Procedures for Electric and Electronic Products.》

GB/T2423 《Basic Testing Procedures for Electric and Electronic Products》 IEC61747-1 《SIXTH PARTGB2828`2829-87《National Standard of PRC》

4 Definitions

4.1 Definitions of Vop

The definitions of threshold voltage Vth1, Vth2 the following typical waveforms are applied on liquid crystal by the method of equalized voltage for each duty and bias.



 $\ \, \textcircled{1}$ Vth1: The voltage which the brightness of segment indicates 50% of saturated value on the conditions of selected waveform

(f_f=80Hz, Φ =10° θ =270° at 25°C)

② Vth2: The voltage which the brightness of segment indicates 50% of saturated value on the conditions of non-selected waveform

(f_f=80Hz,
$$\Phi$$
=10° θ =270° at 25°C)

③ Vop: (Vth1(50%)+Vth2(50%))/2 $(f_f=80Hz, \Phi=10^{\circ} \theta=270^{\circ} at 25^{\circ}C)$

4.2 Definition of Response Time Tr, Td

①Tr: The time required which the brightness of segment becomes 10% from 100% when waveform is switched to selected one from non-selected one. (f_f =80Hz, Φ =10° θ =270°at 25 °C)

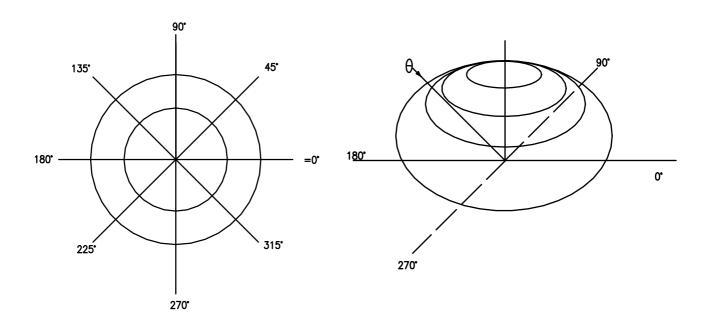
②Td: The time required which the brightness of segment becomes 90% from 10% when waveform is switched to selected one from selected one. (f_f =80Hz, Φ=10°θ=270°at 25°C)

4.3 Definition of Contrast Ratio Cr

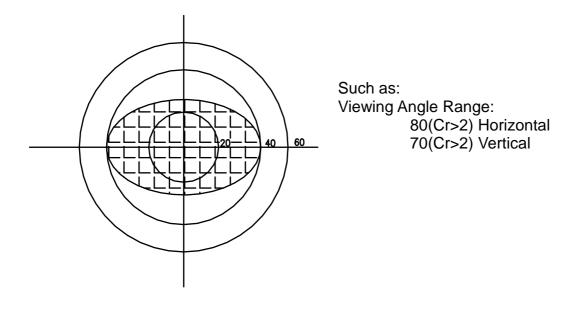
Cr=A/B

- ① A: Segments brightness in case of non-selected waveform
- ② B: Segments brightness in case of selected waveform

4.4 Definition of Angle and Viewing Range



Angular Graph: Constrast Ratio



5 Technology Specifications

5.1 Feature

This single-display module is suitable for use in Multidedia Player products.

The LCD adopts one backlight with High brightness 10-lamps white LED.

- 1) Construction: 4.3" a -Si color TFT-LCD, White LED backlight.
- 2) LCD:
 - 2.1 Amorphous-TFT 4.3-inch display, transmissive, normally white type.
 - 2.2 480(RGB)×272 dots Matrix.
 - 2.3 Narrow-contact ledge technique.
 - 2.4 LCD Driver IC: HX8257 \times 1.
- 3) Low cross talk by frame rate modulation.
- 4) 262K Color ,24bit RGB interface.
- 5) Video signal interface: Parallel RGB.

5.2 Mechanical Specifications

Item	Specifications	Unit
Dimensional outline	105.6(W) ×67.3(H)×2.85 (T)	mm
TP outline		mm
TP(V.A)		mm
TP(A.A)		mm
Active area	95.04(W) ×53.86 (H)	mm
Pixel size	198(W) ×198(H)	um
Resolution	480(RGB) × 272	pixel

5.3 Absolute Max. Rating

ltem	Symbol	Value			Unit	Remark	
пеш		Min	typ	Max	Offic	Remark	
power supply	VCC	1.8	3.0	3.6	V		
Input high voltage	V _{IH}	0.8VCC	-	VCC	V		
Input low voltage	V_{IL}	0	-	0.2VCC	V		
Operating temperature	T _{OPR}	-20		+70	$^{\circ}$		
Storage temperature	T _{STG}	-30		+80	$^{\circ}$		
Clock frequency	F _{CLK}	-	9	15	MHz	Note1	

Note: For parallel RGB interface, maximum clock frequency is 15MHz, For serial RGB interface, maximum clock frequency is 33MHz,

5.4 Electrical Characteristics (VSS=0V,Ta=-20 to 70℃)

Symbol	Parameter	Test condition	Min.	Spec. Typ.	Max.	Uni
VDDIO	Power supply pin of IO pins	Recommend Operating Voltage Possible Operating Voltage	1.8	-	3.6	V
VCI	Booster Reference Supply Voltage Range	Recommend Operating Voltage Possible Operating Voltage	≥ VDDIO & ≥ 3	-	3.6	v
Isleep	Sleep mode current	- 110	-	50		μΑ
l _{dp}	Operating mode current	VCI■3.3V	-	13	15	m/
VCL	Negative Vol Output Voltage	No panel loading	- VCI	-	- VCI+0.7	٧
VCIX2	V _{CIX2} primary booster efficiency ⁽¹⁾	No panel loading, ITO for V _{CIX2} , V _{CI} and V _{CHS} ■ 10 Ohm	5.2	5.4	5.6	٧
VDC	V _{DC} Output Voltage	VDC[3:0]=1011	4.9	5	5.1	٧
VGH	Gate driver High Output Voltage	No panel loading; 3x booster	84	89.5	-	%
.0.1	Booster efficiency ⁽²⁾	No panel loading; 4x booster	80	88.5	•	%
VGL	Gate driver Low Output Voltage	V _{GL} -2 x VDC	-10	-10	-9	٧
	VCOM High Output Voltage(3)	-	-3%	COMC+COMPP	3%	V
	VCOM Low Output Voltage ⁽³⁾	•	-3%	COMC-COMPP	3%	V
	V _{LCD} Output Voltage	VRH[5:0]=100100	4.41	4.51	4.61	V
V _{OH1}	Logic High Output Voltage	I out = -100μA	0.9*V _{DDIO}	-	V _{DD}	V
V_{VD}	Source Output Voltage Deviation	-	-	±20	±30	m\
Vos	Source Output Voltage Offset	-	-	-	±30	m\
V _{OL1}	Logic Low Output Voltage	I out = 100μA	0	-	0.1*V _{DDIO}	٧
V _{IH1}	Logic High Input voltage	-	0.8*V _{DDIO}	-	V _{DDIO}	V
V_{IL1}	Logic Low Input voltage	-	0	-	0.2*V _{DDIO}	٧
I _{OH}	Logic High Output Current Source	V out ■ VDD - 0.4V	50	-	-	μ
l _{OL}	Logic Low Output Current Drain	V out = 0.4V	-	-	-50	μΑ
loz	Logic Output Tri-state Current Drain Source	-	-1	-	1	μ/
Іцлін	Logic Input Current	-	-1	-	1	µ/

Note: (1) VCIX2 efficiency = VCIX2 / (2 x VCI) x 100%

(2) VGH efficiency = VGH / (VDC x n) x 100% (where n = booster factor)

(3) VCOML < 0V, VCOMH < VCIX2J

5.5 Optical specifications

Parame	eter	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
	Horizontal	Θ_3		40	45	-	Deg.	
Viewing Angle	попиона	Θ ₉	CR > 10	40	45	-	Deg.	Normal Pol
range	Vertical	Θ ₁₂	CR > 10	15	20	-	Deg.	Note 1
	vertical	Θ_6		30	40	-	Deg.	Note
Luminance Co	ntrast ratio	CR	Θ = 0°	350	500			Note 2
Transmitt	ance	T(%)	⊙ = 0°	6.2	6.5	-	%	Base on C light Note 3
White Ohre	matiait.	X _w	Θ = 0°	0.278	0.298	0.318		
White Chro	maticity	y _w	9=0	0.311	0.331	0.351		Note 4 CF Glass
	Red	X _R	Θ = 0°	0.587	0.607	0.627		
	Reu	y _R		0.310	0.330	0.350		
Reproduction	Green	X_G		0.258	0.278	0.298		
of color	Green	У _G		0.526	0.546	0.566		
	Blue	X _B		0.121	0.141	0.161		
		y _B		0.138	0.158	0.178		
Throchold)					2.3		V	Figure 2
Threshold Voltage		Vth			1.27		>	Figure 2
Response (Rising + F		T _{RT}	Ta= 25° C Θ = 0°	-	20		ms	Note 5

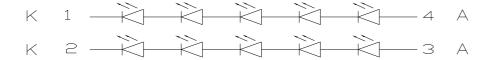
- Notes: 1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see Figure 3 shown in Appendix).
 - Contrast measurements shall be made at viewing angle of Θ= 0 and at the center
 of the LCD surface. Luminance shall be measured with all pixels in the view field
 set first to white, then to the dark (black) state.
 (see Figure 3) Luminance Contrast Ratio (CR) is defined mathematically.

- 3. Transmittance is the Value with Polarizer
- 4. The color chromaticity coordinates specified in Table 4 shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel. Measurement condition is C- light Source & Halogen Lampe
- 5. The electro-optical response time measurements shall be made as Figure 4 by switching the "data" input signal ON and OFF. The times needed for the transmittance to change from 10% to 90% is Tr, and 90% to 10% is Td.

5.6 LED back light specification (10 White Chips)

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	Vf	lf=40mA	15	16	17	V
Uniformity (with L/G)	∆ B p	lf=40mA	80	-	-	%
Luminance for LCD	L _V	If=40mA	5200	-	-	cd/m ²

LED CIRCUIT

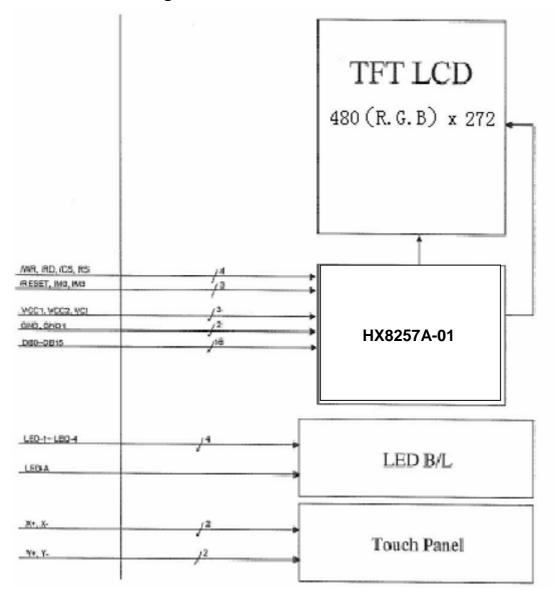


5.7 Interface Pin Connections

PIN NO.	Symbol	Description
1	LED-K	LED backlight(Cathode)
2	LED-A	LED backlight(anode)
3	GND	Ground
4	VCC	Power supply (Digital +3.0V)
5-12	R0-R7	Red Data
13-20	G0-G7	Green Data
21-28	B0-B7	Blue Data
29	GND	Ground
30	CLK	Clock signal
31	DISP	Display on/off
32	HSYNC	Horizontal sync input in RGB mode (short to GND if not used)
33	VSYNC	Vertical sync input in RGB mode (short to GND if not used)
34	DEN	Data Enable
35	NC	NC
36	GND	Ground
37	NC	NC
38	NC	NC
39	NC	NC
40	NC	NC

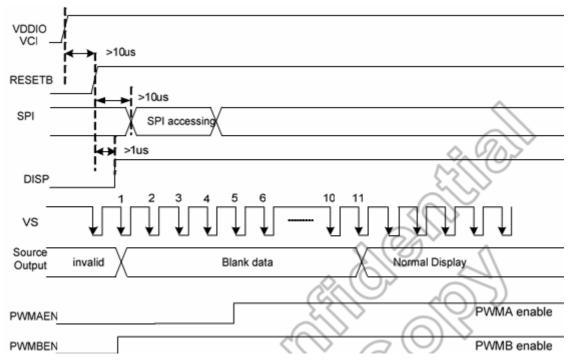
6 Signal timing diagram and Circuit block diagram

6.1 Circuit block diagram

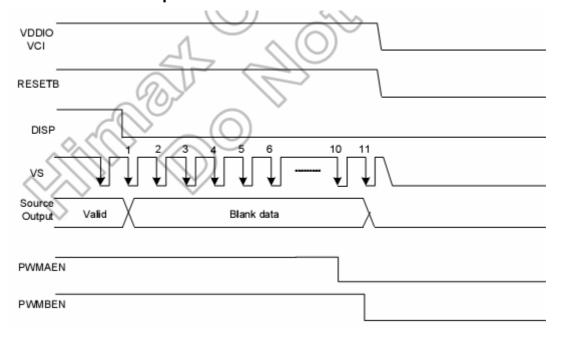


6.2 Signal Timing Diagram

6.2.1 Power ON Sequence



6.2.2 Power OFF Sequence



6.2.3 Timing Diagram of interface Signal

(480 RGBx272, T_A=25°C, VDDIO=1.8V to 3.6V, DVSS= 0V)

Parameter	Symbol		Spec.			
Parameter	_	Min.	Тур.	Max.	Unit	
Clock cycle	f _{CLK} ⁽¹⁾	٠	7	15 \	\\MHz	
Hsync cycle	1/th	-0.	17.14	S/	√ KHz	
Vsync cycle	1/tv	2	59.94	() Hz	
Horizontal Signal		5.	>		^	
Horizontal cycle	th	525	525	605	CLK	
Horizontal display period	thd ⁴	480	480	480	CLK	
Horizontal front porch	thf	2	((2)	82	CLK	
Horizontal pulse width	thp ⁽²⁾) 2	41	41	CLK	
Horizontal back porch	thb ⁽²⁾	2	2	41	CLK	
Vertical Signal		2	>			
Vertical cycle	tv	285	286	511	H ⁽¹⁾	
Vertical display period 🔟 📗	tvd <	272	272	272	H ⁽¹⁾	
Vertical front porch	tvf	1/4	2	227	H ⁽¹⁾	
Vertical pulse width	tvp ⁽²⁾	<u> </u>	10	11	H ⁽¹⁾	
Vertical back porch	tvb ⁽²⁾	1	2	11	H ⁽¹⁾	

Note: (1) Unit: CLK-1/fcLk, H-th,

⁽²⁾It is necessary to keep tvp+tvb=12 and thp+thb=43 in sync mode. DE mode is unnecessary to keep it.

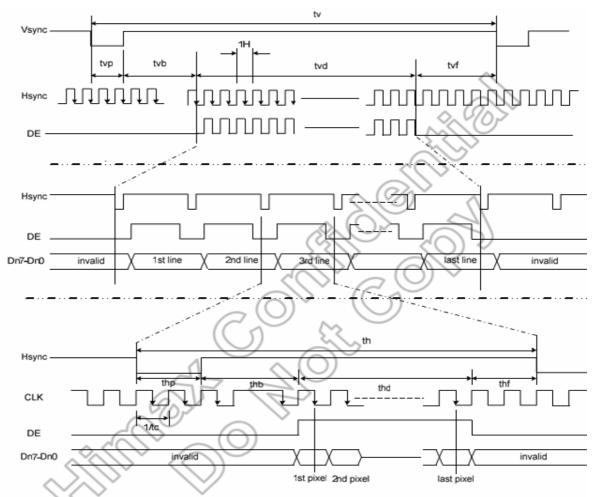


Figure 11.1 Parallel RGB Input Timing

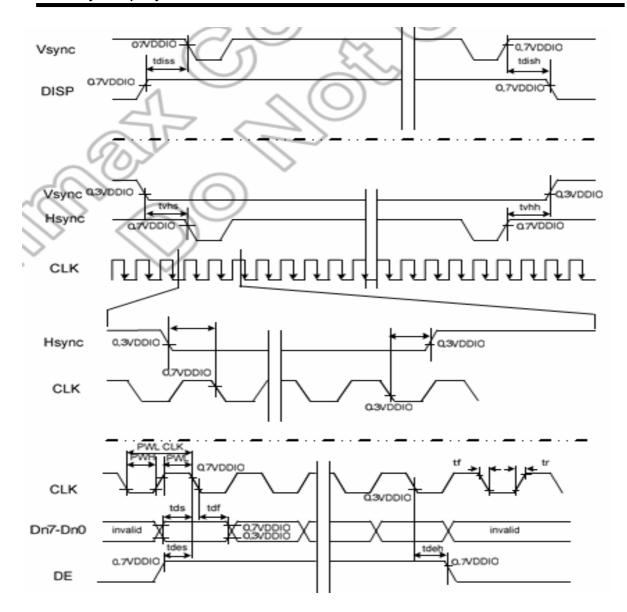
6.2.4 Input setup Timing requirement

(TA=25°C, VDDIO=1.8V to 3.6V, DVSS= 0V, tr (1)=tf (1)=2ns)

Parameter	Symbol		Unit		
Parameter	Symbol	Min.	Тур.	Max.	Oill
DISP setup time	t _{ofiss}	10	-	1	ns
DISP hold time	t _{dash}	10	-	ı	ns
Clock period	PW _{CLK} ⁽²⁾	66.7	-	(ns
Clock pulse high period	PWH ⁽²⁾	26.7	-	\$	ns
Clock pulse low period	PWL ⁽²⁾	26.7	-	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	ns
Hsync setup time	t _{hs}	10	-		ns
Hsync hold time	t _{hh}	10	- <		ns
Data setup time	t _{ds}	10			ns
Data hold time	t _{dh}	10	⟨ {)	∧ ns
DE setup time	t _{des}	10		\	\\ ns
DE hold time	t _{deh}	1.0	5	(ns
Vsync setup time	t _{vhs}	10)	(ns
Vsync hold time	t _{vhh}	10	V - /	7/2	ns

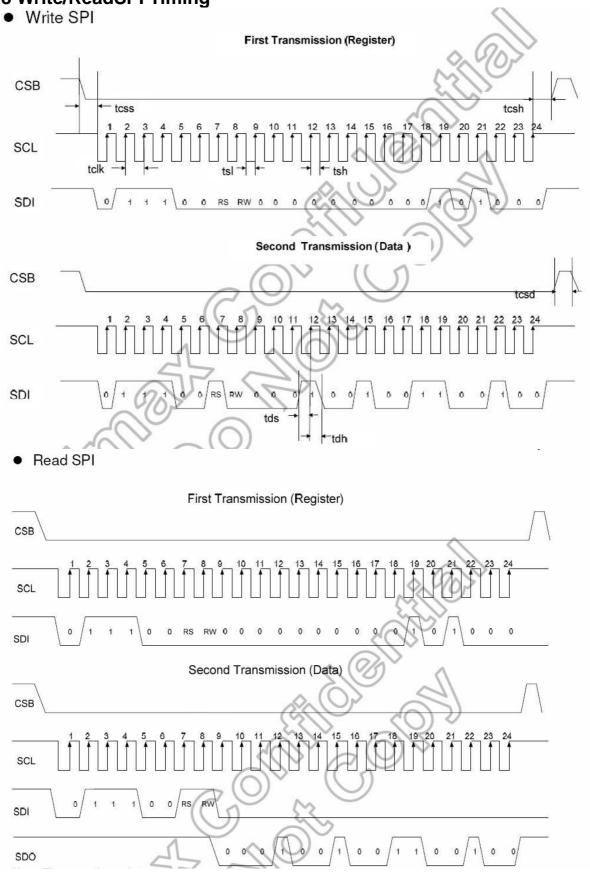
Note: (1) tr, tf is defined 10% to 90% of signal amplitude.

(2) For parallel interface, maximum clock frequency is 15MHz.



7 Initial code

8 Write/ReadSPI Timing



9 Reliability Test Conditions And Methods

NO	Item	Condition	Method
1	High / Low Temperature Storage	80℃/-30℃ 120hrs	Check and record every 48Hrs
2	High / Low Temperature Life	70°C/-20°C 120hrs (operating mode)	Check and record every 48Hrs
3	High Temperature、 High Humidity Operating	60℃,90% RH, 96Hrs	Check and record every 48hrs
4	Thermal Shock	-30°C (30Min) → 25°C (5Min) 80°C (30Min) (conversion time, : 5 sec) 20 cycles	Each 10 cycles end , check
5	Vibration	10Hz~55Hz~10Hz Amplitude: 1.5mm 2hrs for each direction(X,Y,Z)	Each direction end, Check the Appearance and Electrical Characteristics
6	Static Electricity	Gap mood: ±1KV~±8KV (10 times air discharge with positive/negative voltage voltage gap : 1kv) Touch mood: ±1KV~±4KV	Each discharge end, Check the Electrical Characteristics
7	Curve	60 Thousand times, 40 times/min 150° (according to die if exist)	Check and record every 2~4 thousand times
8	Slump	Free faller movement for each side cording angle (75cm High 6 sides 2 angle 2 cording)	End

10 Inspection standard

No	Item	Criterion			
01	Outline Dimension	In accord with drawing			
02	Position-fin ding Dimension Assemble Dimension	In accord with drawing			
		Round type: non displa 3.1 Small area LCD			
	LCD black spots, white spots (Round type)	<u>↓</u>	Unit : mm Dimension	Qualified Quantity	
		$\rightarrow x \leftarrow \uparrow$	D≤0.1	Ignore	
			0.1 <d≤0.15< td=""><td>2</td></d≤0.15<>	2	
			D>0.15	0	
		3.2Large area LCD			
03		J.ZLarge area Lob	Dimension	Qualified Quantity	
		\rightarrow x \leftarrow \uparrow	D≤0.1	Ignore	
			0.1 <d≤0.15< td=""><td>2</td></d≤0.15<>	2	
			0.15 <d≤0.20< td=""><td>1</td></d≤0.20<>	1	
			D>0.20	0	
		C-STN : if D>0.1 , und	C-STN : if D>0.1 , unqualified		

	T	T					
		Unit : mm	4.1	Small	area LCD		
			Length	Width	Qualified Quantity		
		w w	-	≤0.015	Ignore		
		<u> </u>	<u> </u>	≤1.0	0.015 <w≤< td=""><td>2</td><td></td></w≤<>	2	
			≤2.0	0.025	1		
			≤1.0	0.025 <w≤ 0.05</w≤ 	1		
	LCD black		-	D>0.05	According to circle		
04	spots, white spots (Line Style)		4.2Larg	ge area LCD			
			Length	Width	Qualified Quantity		
			-	≤0.015	Ignore		
	LCD		←	₹2.0	0.015 <w≤ 0.025</w≤ 	2	
			≤1.0	0.025 <w≤ 0.05</w≤ 	1		
			-	D>0.05	According to circle		
		Same to NO.3 of	circle	Ignore beyo	015 , unqualified and viewing area		
05	Scratch sightline and surface of LCD is vertical						
06	POL	It is not admissible that POL is beyond the edge of glass, else, unqualified. It is essential that POL is over the 50 percent of width of frame, else, unqualified. According to the drawing in case of special definition.					
07	IC/FPC Bonding	Scratch Reject					

		Intensity Of Adhesion	If lower than specification, reject	
		Gold Fold Twist	Reject	
07	IC/FPC	Silicon	According to outline, no gold outside, seal can not be higher than LCD	
07	Bonding			
08	SMT	Lack of Component Polarity Inverse	If exist, reject	
		Leak Solder、 Virtual Solder	If exist, reject	
		Short Circuit In Solder Point	If exist, reject	
		Tin Ball	If exist, reject	
		Tin Acumination	If visual, reject	
		Height Solder Point	If higher 0.5mm than component. reject	
		Height of component	Either side higher 0.5mm than component, reject	

		Component Shift	X Solder Pad component Y X<3/4Z y>1/3D reject
08	SMT	Few Tin	θ pad pad PCB If θ≤20° reject
		Component Deflection	Component Pad If Y >1/3D reject
		Component Carcass Sideways	Reject

		Component Carcass Sideways	If exist with visual inspection, reject		
		Lot Tin	A: Tin accrete the solder side completely, hollowly, Ok B: Tin accrete the solder side completely, full circle arc, ok C: Jointing include whole solder side, height of tin>50 percent of height of component, reject		
		Few Tin	A: Tin accrete the solder side completely , hollowly ,Ok B: height of tin > 1/3 of solder side of component , ok C: height of tin ≤ 1/3 of solder side of component, reject		
08	SMT	Normal Jointing side			
		Short circuit 、 Open circuit	Forbid		
09	Light	Quality of CSTN Display	1. Rolling strake with visual inspection, forbid 2. Differentness of color in viewing area with visual inspection (full white, red, green, blue), forbid 3. Display change with visual inspection, forbid		

				<u> </u>	
		white	±0.05	±0.05	
					Drive LCD under normal
	Color Of	Red	±0.05	±0.05	condition, 25° C Φ =0 Θ =0
10	CIE Coordinate	Green	±0.05	±0.05	Test white red green blue
	Coordinate	Blue	±0.05	±0.05 pecification	with DMS Record
		_	le custo		
		In accord with product specification		specification Measure lo 3 Adjust to burrow ag press "me display is s	ocation is in Follow Picture orightness instrument tozero, ainst the surface of LCD, easure", record when the
11	Brightness				
				Measure location	
12	CR (Max)	According to specification			ng to product specification re instrument (DMS-501)
13	Response time	According to specification			ng to product specification re instrument (DMS-501)
14	Viewing angle	According to specification			ng to product specification re instrument (DMS-501)
15	Vibration、 Ring	Compare with the sample customer supply		•	with the sample customer en assemble
16	Frequency Of FPC Bend	According to the use of product (main FPC of foldaway cell phone ≥6 thousand)			Measure instrument Bend angle: 150° C in the casement when customer supply

11 Handling Precautions

11.1 Mounting method

The LCD panel of Daxian LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

11.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Salfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Salfur (S) from customer, Responsibility is on customer.

11.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

11.4 packing

- Module employ LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

11.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified

operation temperature.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
 - Usage under the maximum operating temperature, 50%Rh or less is required.

11.6 storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

11.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

12 Precaution for use

12.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

12.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to Daxian , and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

13 Dimensional Outline

